# NX3L2G384

# Dual low-ohmic single-pole single-throw analog switch

Rev. 7 — 26 March 2013

**Product data sheet** 

### 1. General description

The NX3L2G384 is a dual low-ohmic single-pole single-throw analog switch. Each switch has two input/output terminals (nY and nZ) and an active LOW enable input ( $n\overline{E}$ ). When pin  $n\overline{E}$  is HIGH, the analog switch is turned off.

Schmitt trigger action at the enable input (nE) makes the circuit tolerant to slower input rise and fall times. The NX3L2G384 allows signals with amplitude up to  $V_{CC}$  to be transmitted from nY to nZ; or from nZ to nY. Its low ON resistance (0.5  $\Omega$ ) and flatness (0.13  $\Omega$ ) ensures minimal attenuation and distortion of transmitted signals.

### 2. Features and benefits

- Wide supply voltage range from 1.4 V to 4.3 V
- Very low ON resistance (peak):
  - 1.6  $\Omega$  (typical) at  $V_{CC} = 1.4 \text{ V}$
  - 1.0  $\Omega$  (typical) at  $V_{CC} = 1.65 \text{ V}$
  - 0.55 Ω (typical) at V<sub>CC</sub> = 2.3 V
  - 0.50  $\Omega$  (typical) at  $V_{CC} = 2.7 \text{ V}$
  - 0.50  $\Omega$  (typical) at  $V_{CC} = 4.3 \text{ V}$
- High noise immunity
- ESD protection:
  - ♦ HBM JESD22-A114F Class 3A exceeds 7500 V
  - ◆ MM JESD22-A115-A exceeds 200 V
  - CDM AEC-Q100-011 revision B exceeds 1000 V
  - ◆ IEC61000-4-2 contact discharge exceeds 4000 V for switch ports
- CMOS low-power consumption
- Latch-up performance exceeds 100 mA per JESD 78 Class II Level A
- Direct interface with TTL levels at 3.0 V
- Control input accepts voltages above the supply voltage
- High current handling capability (350 mA continuous current under 3.3 V supply)
- Specified from -40 °C to +85 °C and from -40 °C to +125 °C

# 3. Applications

- Cell phone
- PDA
- Portable media player



### Dual low-ohmic single-pole single-throw analog switch

# 4. Ordering information

Table 1. Ordering information

Type number	Package	Package								
	Temperature range	Name	Description	Version						
NX3L2G384GT	–40 °C to +125 °C	XSON8	plastic extremely thin small outline package; no leads; 8 terminals; body 1 $\times$ 1.95 $\times$ 0.5 mm	SOT833-1						
NX3L2G384GD	–40 °C to +125 °C	XSON8	plastic extremely thin small outline package; no leads; 8 terminals; body 3 $\times$ 2 $\times$ 0.5 mm	SOT996-2						
NX3L2G384GM	–40 °C to +125 °C	XQFN8	plastic, extremely thin quad flat package; no leads; 8 terminals; body 1.6 $\times$ 1.6 $\times$ 0.5 mm	SOT902-2						

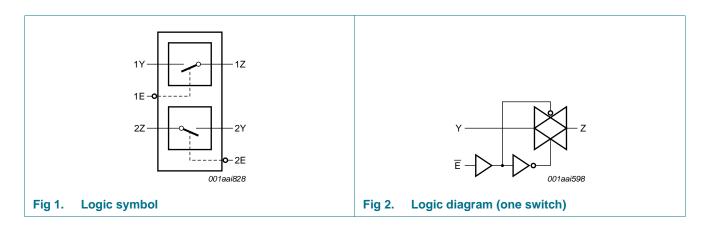
## 5. Marking

### Table 2. Marking codes[1]

Type number	Marking code
NX3L2G384GT	ML2
NX3L2G384GD	ML2
NX3L2G384GM	ML2

<sup>[1]</sup> The pin 1 indicator is located on the lower left corner of the device, below the marking code.

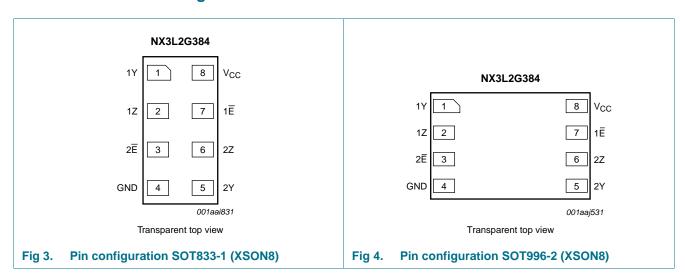
# 6. Functional diagram

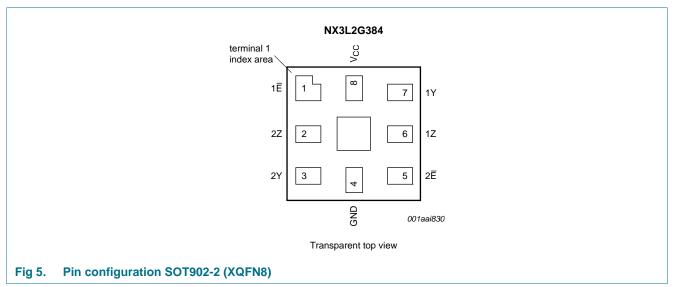


Dual low-ohmic single-pole single-throw analog switch

# 7. Pinning information

### 7.1 Pinning





### Dual low-ohmic single-pole single-throw analog switch

### 7.2 Pin description

Table 3. Pin description

Symbol	Pin		Description	
	SOT833-1 and SOT996-2	SOT902-2		
1Y, 2Y	1, 5	7, 3	independent input or output	
1Z, 2Z	2, 6	6, 2	independent input or output	
GND	4	4	ground (0 V)	
1 <del>E</del> , 2 <del>E</del>	7, 3	1, 5	enable input (active LOW)	
$V_{CC}$	8	8	supply voltage	

## 8. Functional description

Table 4. Function table[1]

Input nE	Switch
L	ON-state
Н	OFF-state

<sup>[1]</sup> H = HIGH voltage level;L = LOW voltage level.

# 9. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
$V_{CC}$	supply voltage		-0.5	+4.6	V
$V_{I}$	input voltage	enable input nE	<u>[1]</u> –0.5	+4.6	V
$V_{SW}$	switch voltage		<u>[2]</u> –0.5	$V_{CC} + 0.5$	V
I <sub>IK</sub>	input clamping current	$V_1 < -0.5 \text{ V}$	-50	-	mΑ
I <sub>SK</sub>	switch clamping current	$V_1 < -0.5 \text{ V or } V_1 > V_{CC} + 0.5 \text{ V}$	-	±50	mΑ
I <sub>SW</sub>	switch current	$V_{SW} > -0.5 \text{ V or } V_{SW} < V_{CC} + 0.5 \text{ V};$ source or sink current	-	±350	mA
		$V_{SW}$ > -0.5 V or $V_{SW}$ < $V_{CC}$ + 0.5 V; pulsed at 1 ms duration, < 10 % duty cycle; peak current	-	±500	mA
T <sub>stg</sub>	storage temperature		-65	+150	°C
P <sub>tot</sub>	total power dissipation	$T_{amb} = -40  ^{\circ}\text{C} \text{ to } +125  ^{\circ}\text{C}$	[3] -	250	mW

<sup>[1]</sup> The minimum input voltage rating may be exceeded if the input current rating is observed.

<sup>[2]</sup> The minimum and maximum switch voltage ratings may be exceeded if the switch clamping current rating is observed but may not exceed 4.6 V.

<sup>[3]</sup> For XSON8 and XQFN8 packages: above 118  $^{\circ}$ C the value of P<sub>tot</sub> derates linearly with 7.8 mW/K.

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# 10. Recommended operating conditions

Table 6. Recommended operating conditions

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$V_{CC}$	supply voltage		1.4	-	4.3	V
VI	input voltage	enable input nE	0	-	4.3	V
$V_{SW}$	switch voltage		<u>[1]</u> 0	-	$V_{CC}$	V
T <sub>amb</sub>	ambient temperature		-40	-	+125	°C
$\Delta t/\Delta V$	input transition rise and fall rate	$V_{CC} = 1.4 \text{ V to } 4.3 \text{ V}$	<u>[2]</u> _	-	200	ns/V

<sup>[1]</sup> To avoid sinking GND current from terminal nZ when switch current flows in terminal nY, the voltage drop across the bidirectional switch must not exceed 0.4 V. If the switch current flows into terminal nZ, no GND current will flow from terminal nY. In this case, there is no limit for the voltage drop across the switch.

### 11. Static characteristics

Table 7. Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground 0 V).

Symbol	Parameter	Conditions	T <sub>ar</sub>	<sub>nb</sub> = 25	°C	T <sub>amb</sub> =	-40 °C to	+125 °C	Unit
			Min	Тур	Max	Min	Max (85 °C)	Max (125 °C)	
$V_{IH}$	HIGH-level input voltage	$V_{CC} = 1.4 \text{ V to } 1.95 \text{ V}$	0.65V <sub>CC</sub>	-	-	0.65V <sub>CC</sub>	-	-	V
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	1.7	-	-	1.7	-	-	V
		$V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$	2.0	-	-	2.0	-	-	V
		$V_{CC} = 3.6 \text{ V to } 4.3 \text{ V}$	0.7V <sub>CC</sub>	-	-	0.7V <sub>CC</sub>	-	-	V
V <sub>IL</sub>	LOW-level	$V_{CC} = 1.4 \text{ V to } 1.95 \text{ V}$	-	-	0.35V <sub>CC</sub>	-	0.35V <sub>CC</sub>	0.35V <sub>CC</sub>	V
	input voltage	$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	-	-	0.7	-	0.7	0.7	V
		$V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$	-	-	0.8	-	0.8	8.0	V
		$V_{CC} = 3.6 \text{ V to } 4.3 \text{ V}$	-	-	$0.3V_{CC}$	-	$0.3V_{CC}$	$0.3V_{CC}$	V
I <sub>I</sub>	input leakage current	enable input $n\overline{E}$ ; $V_I = GND \text{ to } 4.3 \text{ V}$ ; $V_{CC} = 1.4 \text{ V to } 4.3 \text{ V}$	-	-	-	-	±0.5	±1	μΑ
I <sub>S(OFF)</sub>	OFF-state	nY port; see Figure 6							
	leakage	$V_{CC} = 1.4 \text{ V to } 3.6 \text{ V}$	-	-	±5	-	±50	±500	nΑ
	current	$V_{CC} = 3.6 \text{ V to } 4.3 \text{ V}$	-	-	±10	-	±50	±500	nΑ
I <sub>S(ON)</sub>	ON-state	nZ port; see Figure 7							
	leakage	$V_{CC} = 1.4 \text{ V to } 3.6 \text{ V}$	-	-	±5	-	±50	±500	nΑ
	current	$V_{CC} = 3.6 \text{ V to } 4.3 \text{ V}$	-	-	±10	-	±50	±500	nΑ
I <sub>CC</sub>	supply current	$V_I = V_{CC}$ or GND; $V_{SW} = GND$ or $V_{CC}$							
		$V_{CC} = 3.6 \text{ V}$	-	-	100	-	690	6000	nΑ
		$V_{CC} = 4.3 \text{ V}$	-	-	150	-	800	7000	nA

<sup>[2]</sup> Applies to control signal levels.

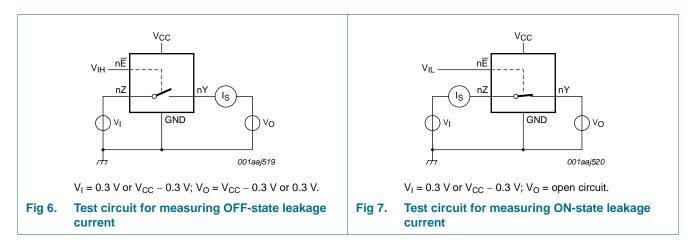
### Dual low-ohmic single-pole single-throw analog switch

 Table 7.
 Static characteristics ...continued

At recommended operating conditions; voltages are referenced to GND (ground 0 V).

Symbol	Parameter	arameter Conditions		T <sub>amb</sub> = 25 °C			$T_{amb}$ = -40 °C to +125 °C			
			Min	Тур	Max	Min	Max (85 °C)	Max (125 °C)		
C <sub>I</sub>	input capacitance		-	1.0	-	-	-	-	pF	
C <sub>S(OFF)</sub>	OFF-state capacitance		-	35	-	-	-	-	pF	
C <sub>S(ON)</sub>	ON-state capacitance		-	110	-	-	-	-	pF	

### 11.1 Test circuits



#### 11.2 ON resistance

Table 8. ON resistance

At recommended operating conditions; voltages are referenced to GND (ground = 0 V); for graphs see Figure 9 to Figure 15.

Symbol	Parameter	Conditions	$T_{amb} = -40$ °C to +85 °C		tions $T_{amb} = -40 \text{ °C to } +85 \text{ °C}$ $T_{amb} = -40 \text{ °C to}$ $+125 \text{ °C}$			Unit
			Min	Typ[1]	Max	Min	Max	
R <sub>ON(peak)</sub> ON resistance (peak)	$V_I = GND \text{ to } V_{CC};$ $I_{SW} = 100 \text{ mA};$ see Figure 8	·						
		$V_{CC} = 1.4 \text{ V}$	-	1.6	3.7	-	4.1	Ω
		V <sub>CC</sub> = 1.65 V	-	1.0	1.6	-	1.7	Ω
		$V_{CC} = 2.3 \text{ V}$	-	0.55	8.0	-	0.9	Ω
		$V_{CC} = 2.7 \text{ V}$	-	0.5	0.75	-	0.9	Ω
		V <sub>CC</sub> = 4.3 V	-	0.5	0.75	-	0.9	Ω

### Dual low-ohmic single-pole single-throw analog switch

Table 8. ON resistance ... continued

At recommended operating conditions; voltages are referenced to GND (ground = 0 V); for graphs see Figure 9 to Figure 15.

Symbol	Symbol Parameter Conditions		T <sub>amb</sub>	$T_{amb} = -40$ °C to +85 °C			T <sub>amb</sub> = -40 °C to +125 °C		
			Min	Typ[1]	Max	Min	Max		
$\Delta R_{ON}$	ON resistance mismatch between channels	$V_I = GND \text{ to } V_{CC};$ $I_{SW} = 100 \text{ mA}$	<u>2]</u>						
		V <sub>CC</sub> = 1.4 V	-	0.04	0.3	-	0.3	Ω	
		V <sub>CC</sub> = 1.65 V	-	0.04	0.2	-	0.3	Ω	
		V <sub>CC</sub> = 2.3 V	-	0.02	0.08	-	0.1	Ω	
		V <sub>CC</sub> = 2.7 V	-	0.02	0.075	-	0.1	Ω	
		$V_{CC} = 4.3 \text{ V}$	-	0.02	0.075	-	0.1	Ω	
R <sub>ON(flat)</sub>	ON resistance (flatness)	$V_I = GND \text{ to } V_{CC};$ $I_{SW} = 100 \text{ mA}$	<u>3]</u>						
		V <sub>CC</sub> = 1.4 V	-	1.0	3.3	-	3.6	Ω	
		V <sub>CC</sub> = 1.65 V	-	0.5	1.2	-	1.3	Ω	
		V <sub>CC</sub> = 2.3 V	-	0.15	0.3	-	0.35	Ω	
		$V_{CC} = 2.7 \text{ V}$	-	0.13	0.3	-	0.35	Ω	
		$V_{CC} = 4.3 \text{ V}$	-	0.2	0.4	-	0.45	Ω	

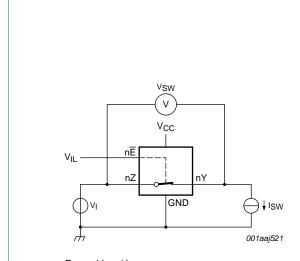
<sup>[1]</sup> Typical values are measured at  $T_{amb}$  = 25 °C.

<sup>[2]</sup> Measured at identical V<sub>CC</sub>, temperature and input voltage.

<sup>[3]</sup> Flatness is defined as the difference between the maximum and minimum value of ON resistance measured at identical V<sub>CC</sub> and temperature.

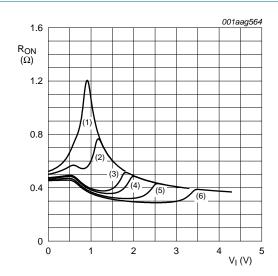
### Dual low-ohmic single-pole single-throw analog switch

### 11.3 ON resistance test circuit and graphs



 $R_{ON} = V_{SW} / I_{SW}$ 

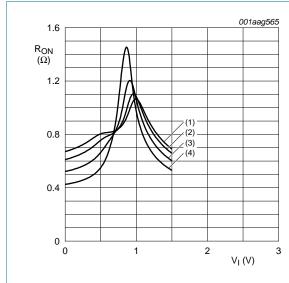
Fig 8. Test circuit for measuring ON resistance



- (1)  $V_{CC} = 1.5 \text{ V}.$
- (2)  $V_{CC} = 1.8 \text{ V}.$
- (3)  $V_{CC} = 2.5 \text{ V}.$
- (4)  $V_{CC} = 2.7 \text{ V}.$
- (5)  $V_{CC} = 3.3 \text{ V}.$
- (6)  $V_{CC} = 4.3 \text{ V}$ . Measured at  $T_{amb} = 25 \,^{\circ}\text{C}$ .

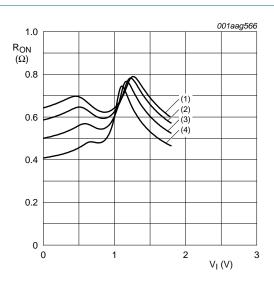
Fig 9. Typical ON resistance as a function of input voltage

### Dual low-ohmic single-pole single-throw analog switch



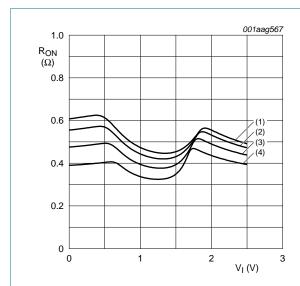
- (1)  $T_{amb} = 125 \, ^{\circ}C$ .
- (2)  $T_{amb} = 85 \, ^{\circ}C$ .
- (3)  $T_{amb} = 25 \, ^{\circ}C$ .
- (4)  $T_{amb} = -40 \, ^{\circ}C$ .

Fig 10. ON resistance as a function of input voltage;  $V_{CC} = 1.5 \text{ V}$ 



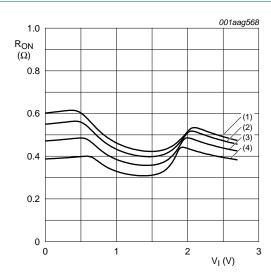
- (1)  $T_{amb} = 125 \, ^{\circ}C$ .
- (2)  $T_{amb} = 85 \, ^{\circ}C$ .
- (3)  $T_{amb} = 25 \, ^{\circ}C$ .
- (4)  $T_{amb} = -40 \, ^{\circ}C$ .

Fig 11. ON resistance as a function of input voltage;  $V_{CC} = 1.8 \text{ V}$ 



- (1)  $T_{amb} = 125 \, ^{\circ}C.$
- (2)  $T_{amb} = 85 \, ^{\circ}C$ .
- (3)  $T_{amb} = 25 \, ^{\circ}C$ .
- (4)  $T_{amb} = -40 \, ^{\circ}C$ .

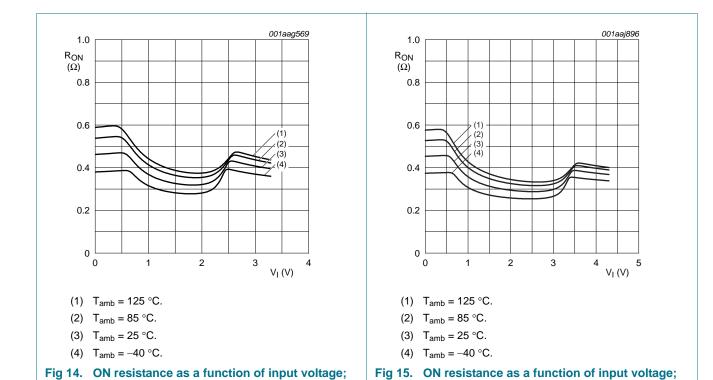
Fig 12. ON resistance as a function of input voltage;  $V_{CC} = 2.5 \text{ V}$ 



- (1)  $T_{amb} = 125 \,^{\circ}C$ .
- (2)  $T_{amb} = 85 \, ^{\circ}C$ .
- (3)  $T_{amb} = 25 \, ^{\circ}C$ .
- (4)  $T_{amb} = -40 \, ^{\circ}C$ .

Fig 13. ON resistance as a function of input voltage;  $V_{CC} = 2.7 \text{ V}$ 

### Dual low-ohmic single-pole single-throw analog switch



### 12. Dynamic characteristics

Table 9. Dynamic characteristics

 $V_{CC} = 3.3 \text{ V}$ 

At recommended operating conditions; voltages are referenced to GND (ground = 0 V); for load circuit see Figure 17.

 $V_{CC} = 4.3 V$ 

Symbol Parameter Co		Conditions	T <sub>amb</sub> = 25 °C			T <sub>amb</sub> =	$T_{amb} = -40  ^{\circ}\text{C} \text{ to } +125  ^{\circ}\text{C}$		
			Min	Typ[1]	Max	Min	Max (85 °C)	Max (125 °C)	
t <sub>en</sub>	enable time	nE to nZ or nY; see Figure 16							
		$V_{CC} = 1.4 \text{ V to } 1.6 \text{ V}$	-	27	41	-	44	48	ns
		$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$	-	23	35	-	37	40	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	-	17	26	-	28	31	ns
		$V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$	-	14	24	-	25	27	ns
		$V_{CC} = 3.6 \text{ V to } 4.3 \text{ V}$	-	14	24	-	25	27	ns
t <sub>dis</sub>	disable time	nE to nZ or nY; see <u>Figure 16</u>							
		V <sub>CC</sub> = 1.4 V to 1.6 V	-	9	17	-	19	21	ns
		$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$	-	7	13	-	14	15	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	-	4	8	-	9	10	ns
		$V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$	-	3	7	-	8	9	ns
		$V_{CC} = 3.6 \text{ V to } 4.3 \text{ V}$	-	3	7	-	8	9	ns

<sup>[1]</sup> Typical values are measured at  $T_{amb}$  = 25 °C and  $V_{CC}$  = 1.5 V, 1.8 V, 2.5 V, 3.3 V and 4.3 V respectively.

NX3L2G384

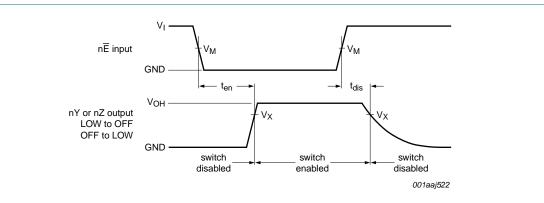
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### Dual low-ohmic single-pole single-throw analog switch

### 12.1 Waveform and test circuits



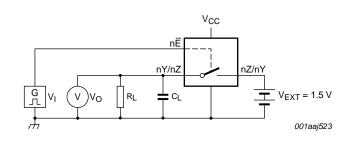
Measurement points are given in Table 10.

Logic level: V<sub>OH</sub> is the typical output voltage that occurs with the output load.

Fig 16. Enable and disable times

Table 10. Measurement points

Supply voltage	Input	Output
V <sub>CC</sub>	V <sub>M</sub>	V <sub>X</sub>
1.4 V to 4.3 V	0.5V <sub>CC</sub>	0.9V <sub>OH</sub>



Test data is given in Table 11.

Definitions test circuit:

 $R_L$  = Load resistance.

 $C_L$  = Load capacitance including jig and probe capacitance.

 $V_{EXT}$  = External voltage for measuring switching times.

Fig 17. Test circuit for measuring switching times

Table 11. Test data

Supply voltage	Input		Load	
V <sub>CC</sub>	V <sub>I</sub>	t <sub>r</sub> , t <sub>f</sub>	C <sub>L</sub>	R <sub>L</sub>
1.4 V to 4.3 V	V <sub>CC</sub>	≤ 2.5 ns	35 pF	50 Ω

### Dual low-ohmic single-pole single-throw analog switch

### 12.2 Additional dynamic characteristics

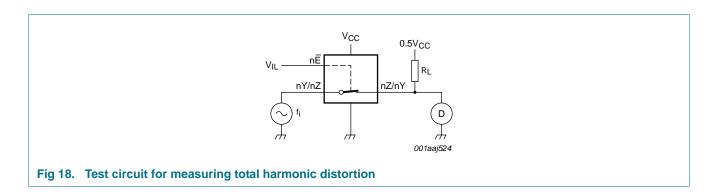
Table 12. Additional dynamic characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V);  $V_l = \text{GND}$  or  $V_{\text{CC}}$  (unless otherwise specified);  $t_r = t_f \le 2.5$  ns.

Symbol Parameter	Parameter	Conditions		T <sub>amb</sub> = 25 °C			Unit
			Min	Тур	Max		
THD total harmonic distortion	$f_i$ = 20 Hz to 20 kHz; $R_L$ = 32 $\Omega$ ; see Figure 18	<u>[1]</u>					
	distortion	$V_{CC} = 1.4 \text{ V}; V_I = 1 \text{ V (p-p)}$		-	0.15	-	%
	$V_{CC} = 1.65 \text{ V}; V_I = 1.2 \text{ V (p-p)}$		-	0.10	-	%	
	$V_{CC} = 2.3 \text{ V}; V_I = 1.5 \text{ V (p-p)}$		-	0.02	-	%	
		$V_{CC} = 2.7 \text{ V}; V_1 = 2 \text{ V (p-p)}$		-	0.02	-	%
		$V_{CC} = 4.3 \text{ V}; V_1 = 2 \text{ V (p-p)}$		-	0.02	-	%
f <sub>(-3dB)</sub>	-3 dB frequency	$R_L = 50 \Omega$ ; see Figure 19	<u>[1]</u>				
	response	V <sub>CC</sub> = 1.4 V to 4.3 V		-	60	-	MHz
$\alpha_{\text{iso}}$ isolation (OFF-state)	$f_i$ = 100 kHz; $R_L$ = 50 $\Omega$ ; see Figure 20	<u>[1]</u>					
		V <sub>CC</sub> = 1.4 V to 4.3 V		-	-90	-	dB
V <sub>ct</sub> crosstalk voltage	crosstalk voltage	between digital inputs and switch; $f_i = 1 \text{ MHz}$ ; $C_L = 50 \text{ pF}$ ; $R_L = 50 \Omega$ ; see Figure 21					
		V <sub>CC</sub> = 1.4 V to 3.6 V		-	0.2	-	V
	V <sub>CC</sub> = 3.6 V to 4.3 V		-	0.2	-	V	
Xtalk	crosstalk	between switches; $f_i = 100 \text{ kHz}$ ; $R_L = 50 \Omega$ ; see Figure 22	[1]				
	V <sub>CC</sub> = 1.4 V to 4.3 V		-	-90	-	dB	
Q <sub>inj</sub> charge injection	$f_i$ = 1 MHz; $C_L$ = 0.1 nF; $R_L$ = 1 M $\Omega$ ; $V_{gen}$ = 0 V; $R_{gen}$ = 0 $\Omega$ ; see Figure 23						
	V <sub>CC</sub> = 1.5 V		-	3	-	рС	
		V <sub>CC</sub> = 1.8 V		-	3	-	рС
		V <sub>CC</sub> = 2.5 V		-	3	-	рС
		$V_{CC} = 3.3 \text{ V}$		-	3	-	рС
		V <sub>CC</sub> = 4.3 V		-	6	-	рС

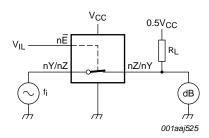
<sup>[1]</sup>  $f_i$  is biased at  $0.5V_{CC}$ .

### 13. Test circuits



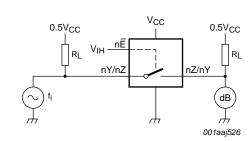
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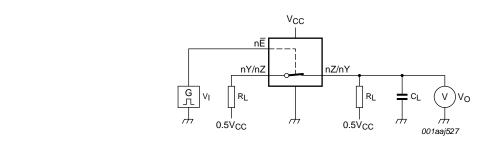
Adjust f<sub>i</sub> voltage to obtain 0 dBm level at output. Increase f<sub>i</sub> frequency until dB meter reads -3 dB.

Fig 19. Test circuit for measuring the frequency response when channel is in ON-state

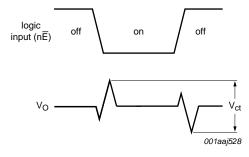


Adjust fi voltage to obtain 0 dBm level at input.

Fig 20. Test circuit for measuring isolation (OFF-state)



a. Test circuit

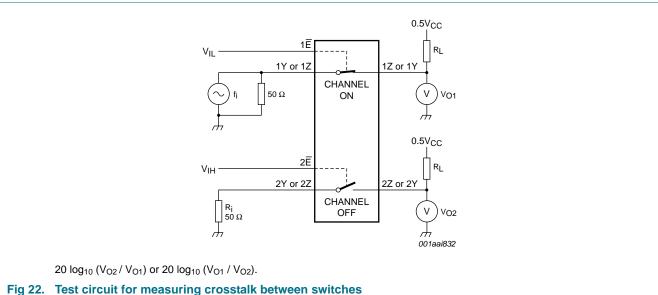


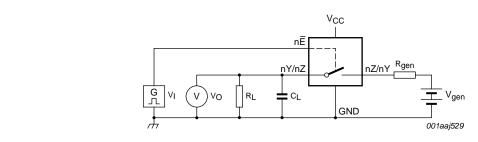
b. Input and output pulse definitions

Fig 21. Test circuit for measuring crosstalk voltage between digital inputs and switch

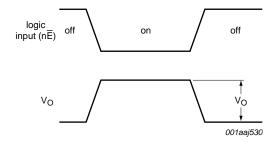
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a. Test circuit



b. Input and output pulse definitions

Definition:  $Q_{inj} = \Delta V_O \times C_L$ .  $\Delta V_{O}$  = output voltage variation. R<sub>gen</sub> = generator resistance.  $V_{gen}$  = generator voltage.

Fig 23. Test circuit for measuring charge injection

### Dual low-ohmic single-pole single-throw analog switch

## 14. Package outline

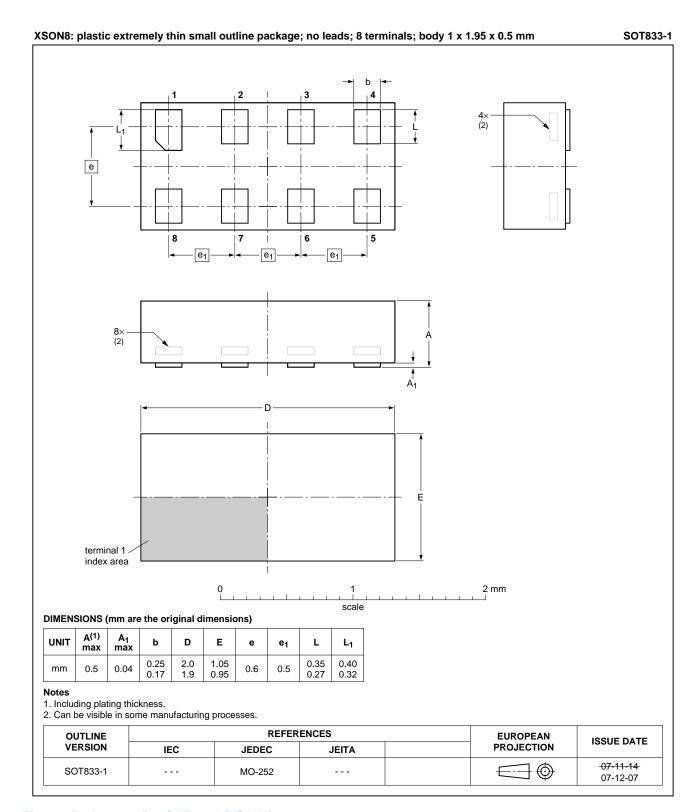


Fig 24. Package outline SOT833-1 (XSON8)

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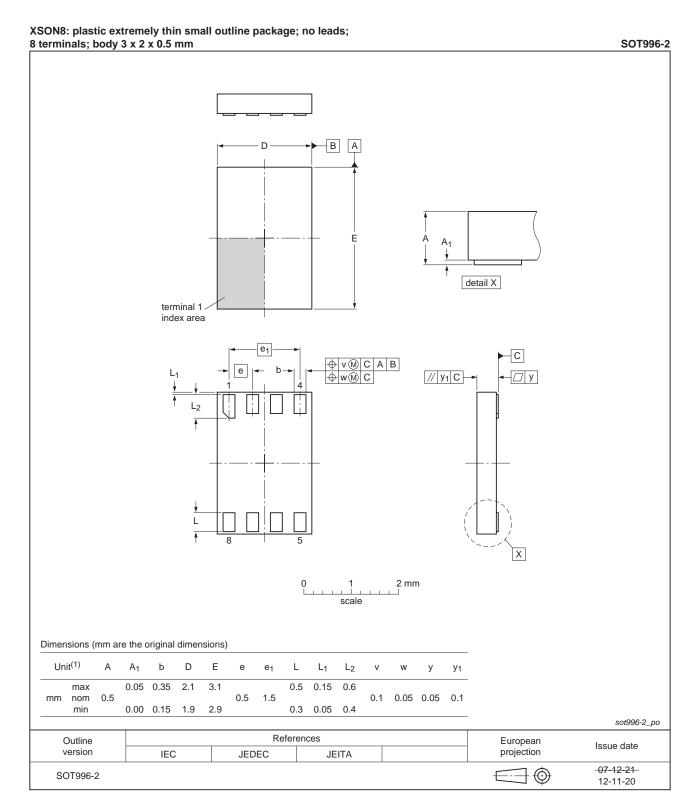


Fig 25. Package outline SOT996-2 (XSON8)

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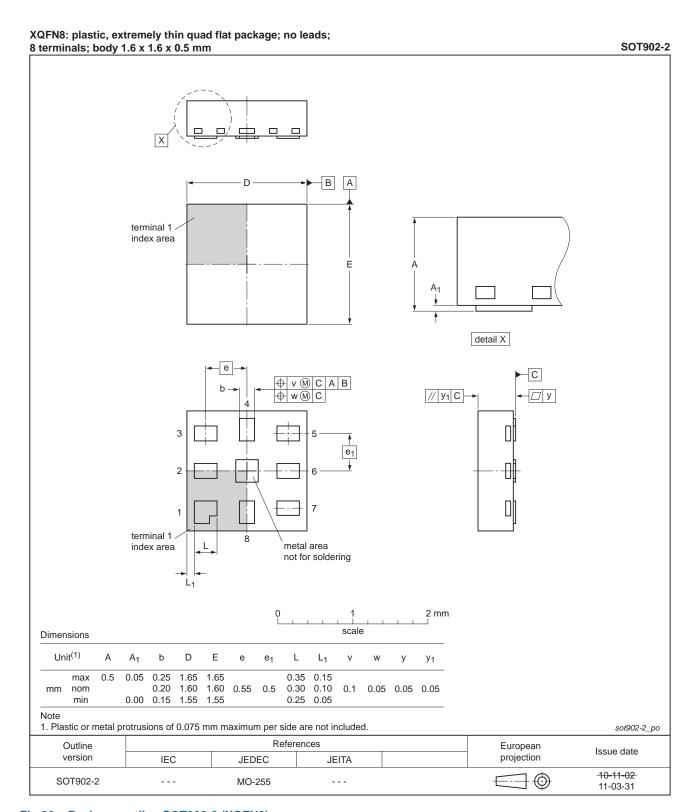


Fig 26. Package outline SOT902-2 (XQFN8)

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### Dual low-ohmic single-pole single-throw analog switch

## 15. Abbreviations

#### Table 13. Abbreviations

Acronym	Description
CDM	Charged Device Model
CMOS	Complementary Metal Oxide Semiconductor
ESD	ElectroStatic Discharge
НВМ	Human Body Model
MM	Machine Model
PDA	Personal Digital Assistant
TTL	Transistor-Transistor Logic

# 16. Revision history

### Table 14. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
NX3L2G384 v.7	20130326	Product data sheet	-	NX3L2G384 v.6
Modifications:	<ul> <li>For type num</li> </ul>	ber NX3L2G384GD XSON8U	has changed to XSO	N8.
NX3L2G384 v.6	20120617	Product data sheet	-	NX3L2G384 v.5
NX3L2G384 v.5	20111107	Product data sheet	-	NX3L2G384 v.4
NX3L2G384 v.4	20101228	Product data sheet	-	NX3L2G384 v.3
NX3L2G384 v.3	20090828	Product data sheet	-	NX3L2G384 v.2
NX3L2G384 v.2	20090415	Product data sheet	-	NX3L2G384 v.1
NX3L2G384 v.1	20080918	Product data sheet	-	-

#### Dual low-ohmic single-pole single-throw analog switch

### 17. Legal information

#### 17.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
- [3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

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